

## TLV5614IYE SLAS391A – JULY 2003 – REVISED AUGUST 2003

# 2.7-V TO 5.5-V, 12-BIT QUAD DAC IN WAFER CHIP SCALE PACKAGE

## FEATURES

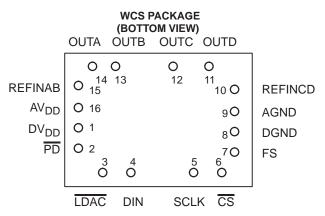
- Four 12-Bit D/A Converters
- Programmable Settling Time of Either 3 μs or 9 μs Typ
- TMS320<sup>™</sup> DSP Family, (Q)SPI<sup>™</sup>, and Microwire<sup>™</sup> Compatible Serial Interface
- Internal Power-On Reset
- Low Power Consumption:
  - 8 mW, Slow Mode 5-V Supply
  - 3.6 mW, Slow Mode 3-V Supply
- Reference Input Buffer
- Voltage Output Range . . . 2× the Reference Input Voltage
- Monotonic Over Temperature
- Dual 2.7-V to 5.5-V Supply (Separate Digital and Analog Supplies)
- Hardware Power Down (10 nA)
- Software Power Down (10 nA)
- Simultaneous Update

## DESCRIPTION

/MV

## **APPLICATIONS**

- Battery Powered Test Instruments
- Digital Offset and Gain Adjustment
- Industrial Process Controls
- Machine and Motion Control Devices
- Communications
- Arbitrary Waveform Generation



The TLV5614IYE is a quadruple 12-bit voltage output digital-to-analog converter (DAC) with a flexible 4-wire serial interface. The serial interface allows glueless interface to TMS320, SPI, QSPI, and Microwire serial ports. The TLV5614IYE is programmed with a 16-bit serial word comprised of a DAC address, individual DAC control bits, and a 12-bit DAC value. The device has provision for two supplies: one digital supply for the serial interface (via pins DV<sub>DD</sub> and DGND), and one for the DACs, reference buffers, and output buffers (via pins AV<sub>DD</sub> and AGND). Each supply is independent of the other, and can be any value between 2.7 V and 5.5 V. The dual supplies allow a typical application where the DAC is controlled via a microprocessor operating on a 3 V supply (also used on pins DV<sub>DD</sub> and DGND), with the DACs operating on a 5 V supply. Of course, the digital and analog supplies can be tied together.

The resistor string output voltage is buffered by a x2 gain rail-to-rail output buffer. The buffer features a Class AB output stage to improve stability and reduce settling time. A rail-to-rail output stage and a power-down mode makes it ideal for single voltage, battery based applications. The settling time of the DAC is programmable to allow the designer to optimize speed versus power dissipation. The settling time is chosen by the control bits within the 16-bit serial input string. A high-impedance buffer is integrated on the REFINAB and REFINCD terminals to reduce the need for a low source impedance drive to the terminal. REFINAB and REFINCD allow DACs A and B to have a different reference voltage then DACs C and D.

The TLV5614IYE is implemented with a CMOS process and is available in a 16-terminal WCS package. The TLV5614IYE is characterized for operation from –40°C to 85°C in a wire-bonded small outline (SOIC) package.

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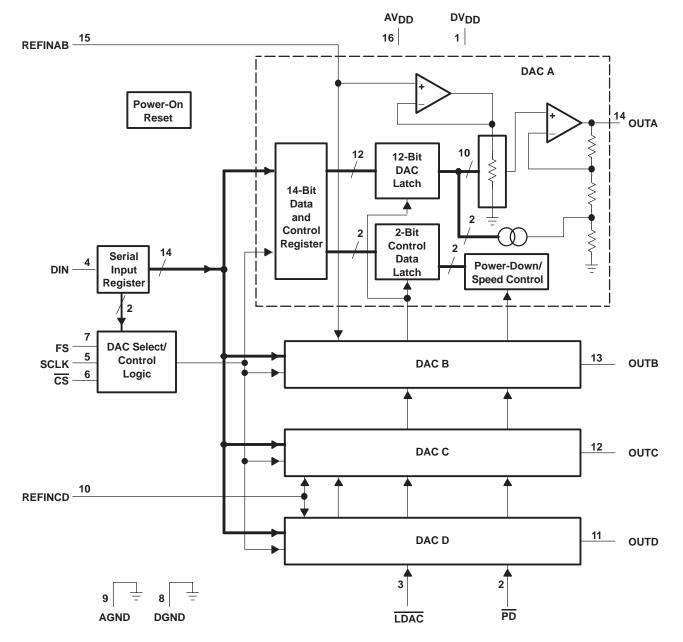
These devices have limited built-in ESD protection. The device should be placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

### **AVAILABLE OPTIONS**

	PACKAGE
ТА	WCS(1) (YE)
-40°C to 85°C	TLV5614IYE

(1) Wafer chip scale package. See Figure 17.

## FUNCTIONAL BLOCK DIAGRAM



## **Terminal Functions**

TERMINAL		I/O	DESCRIPTION						
NAME	NO.	1/0	DESCRIPTION						
AGND	9		Analog ground						
AVDD	16		Analog supply						
CS	6	I	Chip select. This terminal is active low.						
DGND	8		Digital ground						
DIN	4	Ι	Serial data input						
DVDD	1		Digital supply						
FS	7	I	Frame sync input. The falling edge of the frame sync pulse indicates the start of a serial data frame shifted out to the TLV5614IYE.						
PD	2	I	Power down pin. Powers down all DACs (overriding their individual power down settings), and all output stages. This terminal is active low.						
LDAC	3	I	Load DAC. When the LDAC signal is high, no DAC output updates occur when the input digital data is read into the serial interface. The DAC outputs are only updated when LDAC is low.						
REFINAB	15	Ι	Voltage reference input for DACs A and B.						
REFINCD	10	Ι	Voltage reference input for DACs C and D.						
SCLK	5	I	Serial clock input						
OUTA	14	0	DACA output						
OUTB	13	0	DACB output						
OUTC	12	0	DACC output						
OUTD	11	0	DACD output						

## **ABSOLUTE MAXIMUM RATINGS**

over operating free-air temperature range unless otherwise noted<sup>(1)</sup>

	UNIT
Supply voltage, (DV <sub>DD</sub> , AV <sub>DD</sub> to GND)	7 V
Supply voltage difference, (AV <sub>DD</sub> to DV <sub>DD</sub> )	–2.8 V to 2.8 V
Digital input voltage range	-0.3 V to DV <sub>DD</sub> + 0.3 V
Reference input voltage range	-0.3 V to AV <sub>DD</sub> + 0.3 V
Operating free-air temperature range, T <sub>A</sub>	-40°C to 85°C

(1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

## **RECOMMENDED OPERATING CONDITIONS**

		MIN	NOM	MAX	UNIT	
$\Omega_{\rm complexication} = \Omega_{\rm complexication} = \Omega_{\rm complexication}$	5-V supply	4.5	5	5.5	V	
Supply voltage, AV <sub>DD</sub> , DV <sub>DD</sub>	3-V supply	2.7	3	3.3	V	
	DV <sub>DD</sub> = 2.7 V	2			V	
High-level digital input voltage, VIH	DV <sub>DD</sub> = 5.5 V	2.4			V	
Level and d'alter transformer M	DV <sub>DD</sub> = 2.7 V			0.6	N	
Low-level digital input voltage, VIL	DV <sub>DD</sub> = 5.5 V			1	V	
	5-V supply(1)	0	2.048	V <sub>DD</sub> -1.5	N	
Reference voltage, V <sub>ref</sub> to REFINAB, REFINCD terminal	3-V supply(1)	0	1.024	V <sub>DD</sub> -1.5	V	
Load resistance, RL		2	10		kΩ	
Load capacitance, CL				100	pF	
Serial clock rate, SCLK				20	MHz	
Operating free-air temperature	TLV5614IYE	-40		85	°C	
1) Malta and another them. (1) (2) across a structure time for large F						

(1) Voltages greater than  $AV_{DD}/2$  cause output saturation for large DAC codes.



### ELECTRICAL CHARACTERISTICS

over recommended operating free-air temperature range, supply voltages, and reference voltages (unless otherwise noted)

#### STATIC DAC SPECIFICATIONS

STATIC	DAC SPECIFICATIONS		1					
	PARAMETER		TEST CONDITIONS		MIN	TYP	MAX	UNIT
	Resolution				12			bits
	Integral nonlinearity (INL), end po	int adjusted	See Note 1			±1.5	±4	LSB
	Differential nonlinearity (DNL)	See Note 2			±0.5	±1	LSB	
EZS	Zero scale error (offset error at ze	ero scale)	See Note 3				±12	mV
	Zero scale error temperature coe	fficient	See Note 4			10		ppm/⁰C
EG	Gain error		See Note 5				±0.6	% of FS voltage
	Gain error temperature coefficien	t	See Note 6			10		ppm/⁰C
PSRR	Power supply rejection ratio	Zero scale Full scale	See Notes 7 and 8	-		-80 -80		dB dB
INDIVID	UAL DAC OUTPUT SPECIFICATIO	ONS						
Vo	Voltage output range		R <sub>I</sub> = 10 kΩ		0		AV <sub>DD</sub> -0.4	V
	Output load regulation accuracy		$R_L = 2 k\Omega$ vs 10 kΩ			0.1	0.25	% of FS voltage
REFERE	ENCE INPUTS (REFINAB, REFINO	CD)						
VI	Input voltage range		See Note 9		0		AV <sub>DD</sub> -1.5	V
RI	Input resistance					10		MΩ
Cl	Input capacitance					5		pF
	Reference feed through		REFIN = 1 V <sub>pp</sub> at 1 kHz + 1.024 V dc (see Note 10)			-75		dB
	Defense a ferret has defide		REFIN = 0.2 V <sub>pp</sub> + 1.024 V dc	Slow		0.5		N 41 1-
	Reference input bandwidth		large signal Fast			1		MHz
DIGITAL	INPUTS (DIN, $\overline{CS}$ , $\overline{LDAC}$ , $\overline{PD}$							
IIН	High-level digital input current		$V_I = V_{DD}$				±1	μΑ
Ι <sub>ΙL</sub>	Low-level digital input current		$V_{I} = 0 V$				±1	μΑ
Cl	Input capacitance					3		pF
POWER	SUPPLY							
			5-V supply, No load,	Slow		1.6	2.4	mA
			Clock running, All inputs 0 V or V <sub>DD</sub>	Fast		3.8	5.6	
IDD	Power supply current		3-V supply, No load,	Slow		1.2	1.8	m 4
		Clock running, All inputs 0 V or DV <sub>DD</sub>	Fast		3.2	4.8	mA	
	Power down supply current (see	Figure 12)		·		10		nA
(								

(1) The relative accuracy or integral nonlinearity (INL) sometimes referred to as linearity error, is the maximum deviation of the output from the line between zero and full scale excluding the effects of zero code and full-scale errors.

(2) The differential nonlinearity (DNL) sometimes referred to as differential error, is the difference between the measured and ideal 1 LSB amplitude change of any two adjacent codes. Monotonic means the output voltage changes in the same direction (or remains constant) as a change in the digital input code.

(3) Zero-scale error is the deviation from zero voltage output when the digital input code is zero.

(4) Zero-scale-error temperature coefficient is given by:  $E_{ZS} TC = [E_{ZS} (T_{max}) - E_{ZS} (T_{min})]/V_{ref} \times 10^{6}/(T_{max} - T_{min}).$ 

(5) Gain error is the deviation from the ideal output (2  $V_{ref}$  – 1 LSB) with an output load of 10 k $\Omega$  excluding the effects of the zero-error.

(6) Gain temperature coefficient is given by:  $E_G TC = [E_G(T_{max}) - E_G (T_{min})]/V_{ref} \times 10^6/(T_{max} - T_{min}).$ (7) Zero-scale-error rejection ratio (EZS-RR) is measured by varying the AV<sub>DD</sub> from 5 ± 0.5 V and 3 ± 0.3 V dc, and measuring the proportion of this signal imposed on the zero-code output voltage.

(8) Full-scale rejection ratio (EG-RR) is measured by varying the AV<sub>DD</sub> from 5±0.5 V and 3±0.3 V dc and measuring the proportion of this signal imposed on the full-scale output voltage after subtracting the zero scale change.

(9) Reference input voltages greater than V<sub>OO</sub>/2 cause output saturation for large DAC codes

(10) Reference feedthrough is measured at the DAC output with an input code = 000 hex and a Vref (REFINAB or REFINCD) input = 1.024 Vdc + 1 Vpp at 1 kHz.

## **ELECTRICAL CHARACTERISTICS (CONTINUED)**

over recommended operating free-air temperature range, supply voltages, and reference voltages (unless otherwise noted)

ANALOG OU	TPUT DYNAMIC PERFORMA	NCE							
	PARAMETER	TEST CONDITIONS		MIN	TYP	MAX	UNIT		
0.0	Output along as to	$C_{L} = 100 \text{ pF}, R_{L} = 10 \text{ k}\Omega,$ Fast			5		V/µs		
SR	Output slew rate	$V_{O} = 10\%$ to 90%, $V_{ref} = 2.048$ V, 1024 V		1		V/µs			
	Quitaut a attling time	To ± 0.5 LSB, C <sub>L</sub> = 100 pF,			3	5.5			
t <sub>S</sub>	Output settling time	$R_L = 10 \text{ k}\Omega$ , See Notes 1 and 3	Slow		9	20	μs		
<b>+</b> / \	Output settling time, code to	To $\pm$ 0.5 LSB, CL = 100 pF, RL = 10 kΩ,	Fast		1				
ts(c)	code	See Note 2	Slow		2		μs		
	Glitch energy	Code transition from 7FF to 800			10		nV-sec		
SNR	Signal-to-noise ratio								
S/(N+D)	Signal to noise + distortion	Sinewave generated by DAC,	<b>F</b> \ /		66				
THD	Total harmonic distortion	Reference voltage = 1.024 at 3 V and 2.048 at $f_s = 400 \text{ KSPS}$ , $f_{OUT} = 1.1 \text{ kHz}$ sinewave, C			-68		dB		
SFDR	Spurious free dynamic range	$R_L = 10 \text{ k}\Omega$ , BW = 20 kHz	70						
DIGITAL INPU	JT TIMING REQUIREMENTS								
tsu(CS-FS)	Setup time, CS low before FS	3↓		10			ns		
<sup>t</sup> su(FS–CK)	Setup time, FS low before firs	t negative SCLK edge		8			ns		
<sup>t</sup> su(C16–FS)	Setup time, sixteenth negative rising edge of FS	teenth negative SCLK edge after FS low on which bit D0 is sampled before					ns		
t <sub>su</sub> (C16–CS)		SCLK edge after D0 is sampled before $\overline{\text{CS}}$ rising positive edge to update the DAC, then the setup nd $\overline{\text{CS}}$ rising edge.	10			ns			
twH	Pulse duration, SCLK high		25			ns			
t <sub>wL</sub>	Pulse duration, SCLK low						ns		
<sup>t</sup> su(D)	Setup time, data ready before	e SCLK falling edge		8			ns		
<sup>t</sup> h(D)	Hold time, data held valid afte	r SCLK falling edge		5			ns		
<sup>t</sup> wH(FS)	Pulse duration, FS high			20			ns		

(1) Settling time is the time for the output signal to remain within ±0.5 LSB of the final measured value for a digital input code change of FFF hex to 080 hex for 080 hex to FFF hex.

(2) Settling time is the time for the output signal to remain within ±0.5 LSB of the final measured value for a digital input code change of one count.

(3) Limits are ensured by design and characterization, but are not production tested.



PARAMETER MEASUREMENT INFORMATION

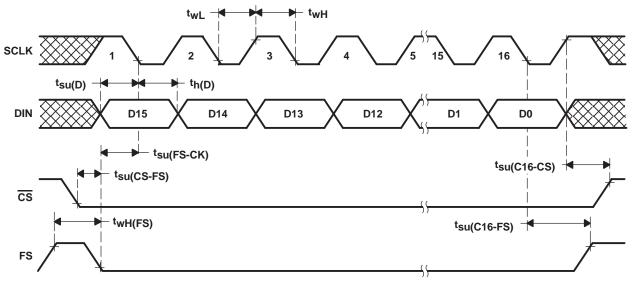
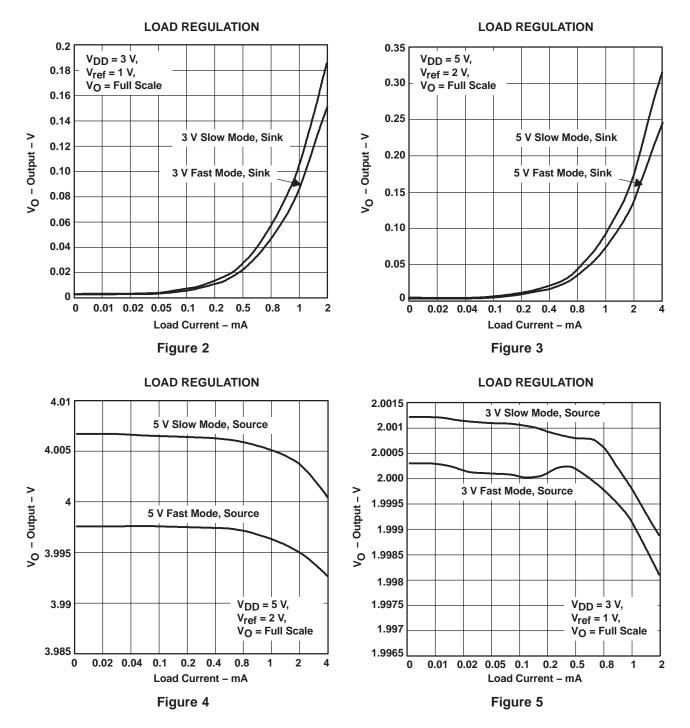


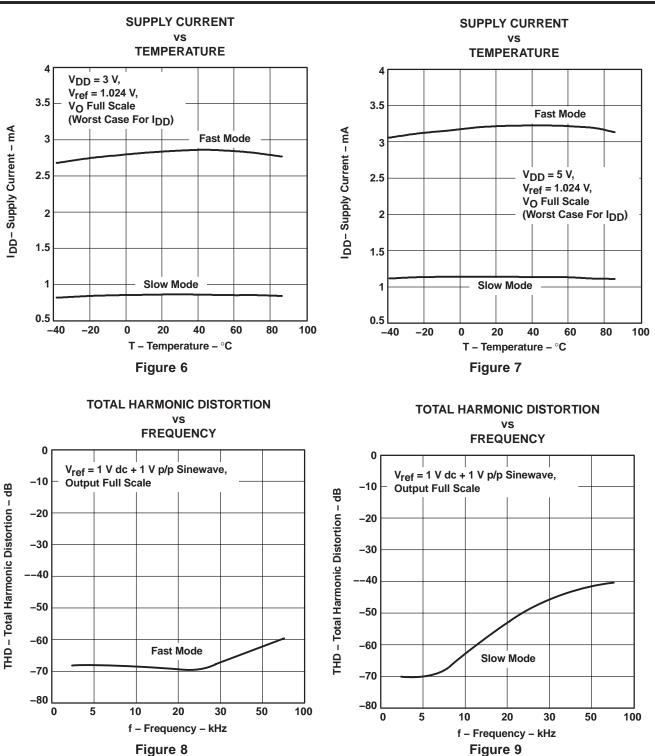
Figure 1. Timing Diagram

## **TYPICAL CHARACTERISTICS**

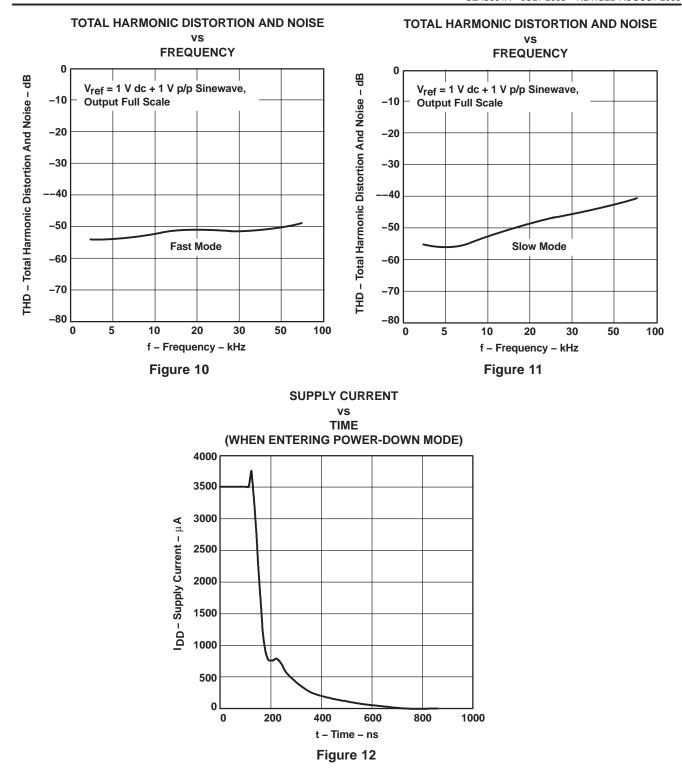


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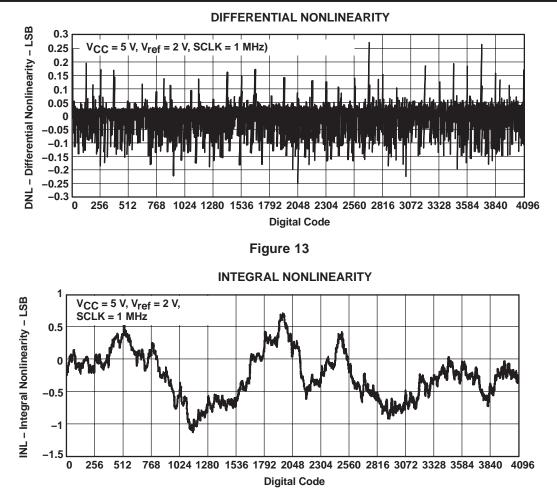


Figure 14

## **APPLICATION INFORMATION**

## **GENERAL FUNCTION**

The TLV5614IYE is a 12-bit single supply DAC based on a resistor string architecture. The device consists of a serial interface, speed and power down control logic, a reference input buffer, a resistor string, and a rail-to-rail output buffer.

The output voltage (full scale determined by external reference) is given by:

$$2 \text{ REF } \frac{\text{CODE}}{2^n} [V]$$

where REF is the reference voltage and CODE is the digital input value within the range of  $0_{10}$  to  $2^n-1$ , where n=12 (bits). The 16-bit data word, consisting of control bits and the new DAC value, is illustrated in the *data format* section. A power-on reset initially resets the internal latches to a defined state (all bits zero).

## SERIAL INTERFACE

Explanation of data transfer: First, the device has to be enabled with  $\overline{CS}$  set to low. Then, a falling edge of FS starts shifting the data bit-per-bit (starting with the MSB) to the internal register on the falling edges of SCLK. After 16 bits have been transferred or FS rises, the content of the shift register is moved to the DAC latch, which updates the voltage output to the new level.

The serial interface of the TLV5614IYE can be used in two basic modes:

- Four wire (with chip select)
- Three wire (without chip select)

Using chip select (four wire mode), it is possible to have more than one device connected to the serial port of the data source (DSP or microcontroller). The interface is compatible with the TMS320<sup>™</sup> DSP family. Figure 15 shows an example with two TLV5614IYEs connected directly to a TMS320 DSP.

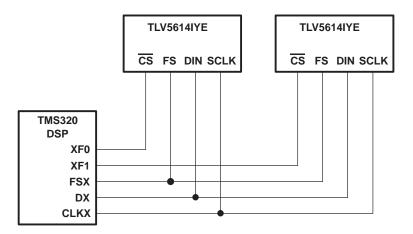


Figure 15. TMS320 Interface

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If there is no need to have more than one device on the serial bus, then  $\overline{CS}$  can be tied low. Figure 16 shows an example of how to connect the TLV5614IYE to a TMS320, SPI, or Microwire port using only three pins.

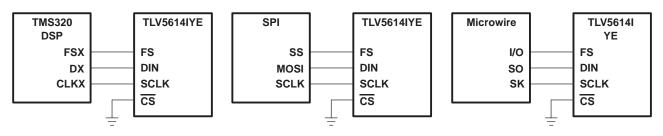


Figure 16. Three-Wire Interface

Notes on SPI and Microwire: Before the controller starts the data transfer, the software has to generate a falling edge on the I/O pin connected to FS. If the word width is 8 bits (SPI and Microwire), two write operations must be performed to program the TLV5614IYE. After the write operation(s), the DAC output is updated automatically on the next positive clock edge following the sixteenth falling clock edge.

## SERIAL CLOCK FREQUENCY AND UPDATE RATE

The maximum serial clock frequency is given by:

$$f_{SCLKmax} = \frac{1}{t_{wH(min)} + t_{wL(min)}} = 20 \text{ MHz}$$

The maximum update rate is:

$$f_{UPDATEmax} = \frac{1}{16 \left( t_{wH(min)} + t_{wL(min)} \right)} = 1.25 \text{ MHz}$$

Note that the maximum update rate is a theoretical value for the serial interface since the settling time of the TLV5614IYE has to be considered also.

## DATA FORMAT

The 16-bit data word for the TLV5614IYE consists of two parts:

- Control bits (D15...D12)
- New DAC value (D11 . . . D0)

D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0
A1	A0	PWR	SPD	New DAC value (12 bits)											

X: don't care

SPD: Speed control bit.  $1 \rightarrow$  fast mode  $0 \rightarrow$  slow mode

 $\mathsf{PWR}:\mathsf{Power}\;\mathsf{control}\;\mathsf{bit}.\quad 1\to\mathsf{power}\;\mathsf{down}\quad 0\to\mathsf{normal}\;\mathsf{operation}$ 

In power-down mode, all amplifiers within the TLV5614IYE are disabled. A particular DAC (A, B, C, D) of the TLV5614IYE is selected by A1 and A0 within the input word.

A1	A0	DAC
0	0	A
0	1	В
1	0	С
1	1	D



## USING TLV5614IYE, WAFER CHIP SCALE PACKAGE (WCSP)

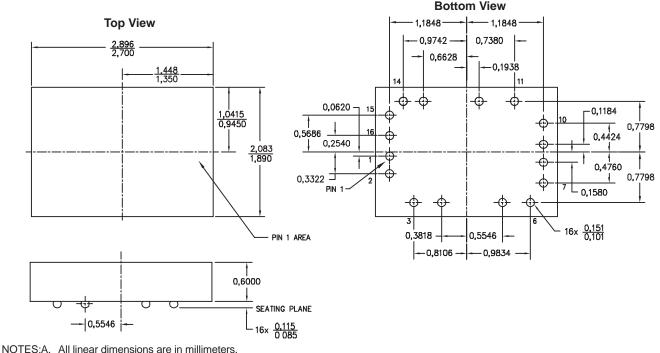
- TLV5614 DIE qualification was done using a wire-bonded small outline (SOIC) package and includes: steady state life, thermal shock, ESD, latch-up, and characterization. This qualified device is orderable as TLV5614ID.
- The wafer chip-scale package (WCS), TLV5614IYE, uses the same DIE as TLV5614ID, but is not qualified. WCS qualification, including board level reliability (BLR), is the responsibility of the customer.
- It is recommended that underfill be used for increased reliability. BLR is application dependent, but may include test such as: temperature cycling, drop test, key push, bend, vibration, and package shear.

The following WCSP information provides the user of the TLV5614IYE with some general guidelines for board assembly.

- Melting point of eutectic solder is 183°C.
- Recommended peak reflow temperatures are in the 220°C to 230°C range.
- The use of underfill is required. The use of underfill greatly reduces the risk of thermal mismatch fails.

Underfill is an epoxy/adhesive that may be added during the board assembly process to improve board level/system level reliability. The process is to dispense the epoxy under the dice after die attach reflow. The epoxy adheres to the body of the device and to the printed-circuit board. It reduces stress placed upon the solder joints due to the thermal coefficient of expansion (TCE) mismatch between the board and the component. Underfill material is highly filled with silica or other fillers to increase an epoxy's modulus, reduce creep sensitivity, and decrease the material's TCE.

The recommendation for peak flow temperatures of 220°C to 230°C is based on general empirical results that indicate that this temperature range is needed to facilitate good wetting of the solder bump to the substrate or circuit board pad. Lower peak temperatures may cause nonwets (cold solder joints).



B. This drawing is subject to change without notice.

Figure 17. TLV5614IYE Wafer Chip Scale Package



### TLV5614IYE INTERFACED TO TMS320C203 DSP

### Hardware Interfacing

Figure 18 shows an example of how to connect the TLV5614IYE to a TMS320C203 DSP. The serial port is configured in burst mode, with FSX generated by the TMS320C203 to provide the frame sync (FS) input to the TLV5614IYE. Data is transmitted on the DX line, with the serial clock input on the CLKX line. The general-purpose input/output port bits IO0 and IO1 are used to generate the chip select (CS) and DAC latch update (LDAC) inputs to the TLV5614IYE. The active low power down (PD) is pulled high all the time to ensure the DACs are enabled.

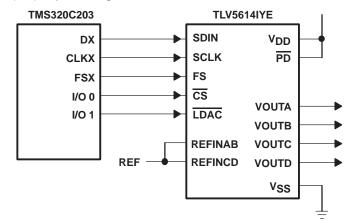


Figure 18. TLV5614IYE Interfaced With TMS320C203

### Software

The application example outputs a differential in-phase (sine) signal between the VOUTA and VOUTB pins, and its quadrature (cosine) signal as the differential signal between VOUTC and VOUTD.

The on-chip timer is used to generate interrupts at a fixed frequency. The related interrupt service routine pulses  $\overline{\text{LDAC}}$  low to update all 4 DACs simultaneously, then fetches and writes the next sample to all 4 DACs. The samples are stored in a look-up table, which describes two full periods of a sine wave.

The synchronous serial port of the DSP is used in burst mode. In this mode, the processor generates an FS pulse preceding the MSB of every data word. If multiple, contiguous words are transmitted, a violation of the tsu(C16–FS) timing requirement occurs. To avoid this, the program waits until the transmission of the previous word has been completed.

```
Processor: TMS320C203 runnning at 40 MHz
;
 Description:
;
 This program generates a differential in-phase (sine) on (OUTA-OUTB) and it's quadrature
   (cosine) as a differential signal on (OUTC-OUTD).
 The DAC codes for the signal samples are stored as a table of 64 12-bit values, describing
;
 2 periods of a sine function. A rolling pointer is used to address the table location in
;
 the first period of this waveform, from which the DAC A samples are read. The samples for
;
 the other 3 DACs are read at an offset to this rolling pointer
;
   DAC
          Function
                        Offset from rolling pointer
;
   Α
          sine
                        0
;
   В
          inverse sine 16
;
   С
          cosine
                        8
;
   D
          inverse cosine24
:
 The on-chip timer is used to generate interrupts at a fixed rate. The interrupt service
;
 routine first pulses LDAC low to update all DACs simultaneously with the values which
 were written to them in the previous interrupt. Then all 4 DAC values are fetched and
;
 written out through the synchronous serial interface. Finally, the rolling pointer is
;
 incremented to address the next sample, ready for the next interrupt.
```

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;		I/	0 and memory	mapped r	regs	 
inclu	de "reag	agm"	_		-	
	-					 
.ps b	0h start					
b	int1					
b	int23					
b	timer_is	sr;				
V	ariables					 
temp r ptr		060h 061h				
r_ptr iosr_stat	.equ 0	062h				
DACa ptr	.equ 0	063h				
DACb_ptr						
DACc_ptr	.equ 0					
DACd_ptr	.equ 0	3				 
		be OR'ed ont				
; all fast mo	de					
DACa_control		1000h				
DACb_control						
DACc_control DACd_control						
	000h					
sinevals	0.01					
.word 008						
.word 009 .word 00A						
.word 000						
.word 00I	061h					
.word 00E						
.word 00F						
.word 00F .word 00F						
.word 00F						
.word 00F						
.word 00E	153h					
.word 00I						
.word 000						
.word 00A .word 009						
.word 008						
.word 006	84h					
.word 005	-					
.word 003						
.word 002 .word 001						
.word 000						
	8Ah					
	64h					
	8Ah					
	)F9h .ADh					
	.ADH 19Fh					
.word 003	C6h					
.word 005	517h					
	84h					
	800h 97Ch					
	E9h					
	l3Ah					
.word 00I	061h					
	153h					
	'07h					
	'76h '9Ch					
	76h					
	07h					
.word 00E	153h					
	061h					
.word 000	∴⊰An					

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.word 00	97Ch
.word 00	
.word 00	
.word 00	517h
.word 00	3C6h
.word 002	29Fh
.word 00	lADh
.word 00	)F9h
.word 00	J8Ah
.word 00	
.word 00	J8Ah
.word 00	)F9h
.word 00	IADh
.word 00	
.word 00	
.word 00	
.word 00	584h
; Main Progra	ann 
	1000h
.entry	
start	
;	
; disable int	cerrupts
	INTM ; disable maskable interrupts
	#Offffh, IFR; clear all interrupts
	#0004h, IMR; timer interrupts unmasked
, set up the	timer
	od set by values in PRD and TDDR
; period = ((	CLKOUT1 period) x (1+PRD) x (1+TDDR)
; period = (0 ; examples fo	CLKOUT1 period) x (1+PRD) x (1+TDDR) or TMS320C203 with 40MHz main clock
; period = (0 ; examples fo ; Timer rate	CLKOUT1 period) x (1+PRD) x (1+TDDR) or TMS320C203 with 40MHz main clock TDDR PRD
; period = (( ; examples fo ; Timer rate ; 80 kHz	CLKOUT1 period) x (1+PRD) x (1+TDDR) or TMS320C203 with 40MHz main clock TDDR PRD 9 24 (18h)
; period = (0 ; examples fo ; Timer rate ; 80 kHz ; 50 kHz	CLKOUT1 period) x (1+PRD) x (1+TDDR) or TMS320C203 with 40MHz main clock TDDR PRD 9 24 (18h) 9 39 (27h)
; period = (0 ; examples fo ; Timer rate ; 80 kHz ; 50 kHz	CLKOUT1 period) x (1+PRD) x (1+TDDR) or TMS320C203 with 40MHz main clock TDDR PRD 9 24 (18h) 9 39 (27h)
; period = (0 ; examples fo ; Timer rate ; 80 kHz ; 50 kHz ; prd val.equ	CLKOUT1 period) x (1+PRD) x (1+TDDR) or TMS320C203 with 40MHz main clock TDDR PRD 9 24 (18h) 9 39 (27h) 0018h
; period = (0 ; examples fo ; Timer rate ; 80 kHz ; 50 kHz ; 50 kHz ; prd_val.equ ccr_val.equ	CLKOUT1 period) x (1+PRD) x (1+TDDR) pr TMS320C203 with 40MHz main clock TDDR PRD 9 24 (18h) 9 39 (27h) 0018h 0029h
; period = (0 ; examples fo ; Timer rate ; 80 kHz ; 50 kHz ; 50 kHz ; prd_val.equ ccr_val.equ splk	CLKOUT1 period) x (1+PRD) x (1+TDDR) pr TMS320C203 with 40MHz main clock TDDR PRD 9 24 (18h) 9 39 (27h) 0018h 0029h #0000h, temp; clear timer
; period = (0 ; examples fo ; Timer rate ; 80 kHz ; 50 kHz ; 50 kHz ; ord_val.equ ccr_val.equ splk out	CLKOUT1 period) x (1+PRD) x (1+TDDR) pr TMS320C203 with 40MHz main clock TDDR PRD 9 24 (18h) 9 39 (27h) 0018h 0029h #0000h, temp; clear timer temp, TIM
; period = (0 ; examples fo ; Timer rate ; 80 kHz ; 50 kHz ; 50 kHz ; ord_val.equ ccr_val.equ splk out splk	CLKOUT1 period) x (1+PRD) x (1+TDDR) pr TMS320C203 with 40MHz main clock TDDR PRD 9 24 (18h) 9 39 (27h) 0018h 0029h #0000h, temp; clear timer temp, TIM #prd_val, temp; set PRD
; period = (0 ; examples fo ; Timer rate ; 80 kHz ; 50 kHz ;	CLKOUT1 period) x (1+PRD) x (1+TDDR) or TMS320C203 with 40MHz main clock TDDR PRD 9 24 (18h) 9 39 (27h) 
; period = (0 ; examples fo ; Timer rate ; 80 kHz ; 50 kHz ; 50 kHz ; ord_val.equ splk out splk out splk	CLKOUT1 period) x (1+PRD) x (1+TDDR) or TMS320C203 with 40MHz main clock TDDR PRD 9 24 (18h) 9 39 (27h) 0018h 0029h #0000h, temp; clear timer temp, TIM #prd_val, temp; set PRD temp, PRD #tcr_val, temp; set TDDR, and TRB=1 for auto-reload
; period = (0 ; examples fo ; Timer rate ; 80 kHz ; 50 kHz ; 50 kHz ;	CLKOUT1 period) x (1+PRD) x (1+TDDR) or TMS320C203 with 40MHz main clock TDDR PRD 9 24 (18h) 9 39 (27h) 
<pre>period = (0 ; examples fo ; Timer rate ; 80 kHz ; 50 kHz ; 50 kHz ; out val.equ ccr_val.equ splk out splk out splk out splk out</pre>	CLKOUT1 period) x (1+PRD) x (1+TDDR) pr TMS320C203 with 40MHz main clock TDDR PRD 9 24 (18h) 9 39 (27h) 0018h 0029h #0000h, temp; clear timer temp, TIM #prd_val, temp; set PRD temp, PRD #tcr_val, temp; set TDDR, and TRB=1 for auto-reload temp, TCR
<pre>; period = (0; ; examples fo; ; Timer rate ; 80 kHz ; 50 kHz ; 50 kHz ; out val.equ ccr_val.equ ccr_val.equ splk out splk out splk out ; configure 1</pre>	CLKOUT1 period) x (1+PRD) x (1+TDDR) pr TMS320C203 with 40MHz main clock TDDR PRD 9 24 (18h) 9 39 (27h) 0018h 0029h #0000h, temp; clear timer temp, TIM #prd_val, temp; set PRD temp, PRD #tcr_val, temp; set TDDR, and TRB=1 for auto-reload temp, TCR
<pre>; period = (0; ; examples fo; ; Timer rate ; 80 kHz ; 50 kHz ; 50 kHz ; ord_val.equ cr_val.equ cr_val.equ splk out splk out splk out splk out splk out splk out splk out splk out splk out</pre>	CLKOUT1 period) x (1+PRD) x (1+TDDR) or TMS320C203 with 40MHz main clock TDDR PRD 9 24 (18h) 9 39 (27h) 0018h 0029h #0000h, temp; clear timer temp, TIM #prd_val, temp; set PRD temp, PRD #tcr_val, temp; set TDDR, and TRB=1 for auto-reload temp, TCR 100/1 as outputs to be : and set high - and set high
<pre>; period = (0; ; examples fo ; Timer rate ; 80 kHz ; 50 kHz ; 50 kHz ; out.equ cr_val.equ cr_val.equ splk out splk out splk out splk out ; Configure 1 ; IO0 CS - a ; IO1 LDAC</pre>	CLKOUT1 period) x (1+PRD) x (1+TDDR) or TMS320C203 with 40MHz main clock TDDR PRD 9 24 (18h) 9 39 (27h) 0018h 0029h #0000h, temp; clear timer temp, TIM #prd_val, temp; set PRD temp, PRD #tcr_val, temp; set TDDR, and TRB=1 for auto-reload temp, TCR 100/1 as outputs to be : and set high - and set high
<pre>; period = (0; ; examples fo; ; Timer rate ; 80 kHz ; 50 kHz ; 50 kHz ; out.equ ccr_val.equ ccr_val.equ splk out splk out splk out ; Configure 1 ; IO0 CS - a ; IO1 LDAC ; in</pre>	CLKOUT1 period) x (1+PRD) x (1+TDDR) pr TMS320C203 with 40MHz main clock TDDR PRD 9 24 (18h) 9 39 (27h) 0018h 0029h #0000h, temp; clear timer temp, TIM #prd_val, temp; set PRD temp, PRD #tcr_val, temp; set TDDR, and TRB=1 for auto-reload temp, TCR TOO/1 as outputs to be : and set high - and set high temp, ASPCR; configure as output
<pre>; period = (0; ; examples fo ; Timer rate ; 80 kHz ; 50 kHz ; 50 kHz ;</pre>	CLKOUT1 period) x (1+PRD) x (1+TDDR) pr TMS320C203 with 40MHz main clock TDDR PRD 9 24 (18h) 9 39 (27h) 0018h 0029h #0000h, temp; clear timer temp, TIM #prd_val, temp; set PRD temp, PRD #tcr_val, temp; set TDDR, and TRB=1 for auto-reload temp, TCR TOO/1 as outputs to be : and set high - and set high temp, ASPCR; configure as output temp
<pre>period = (0 ; examples fo ; Timer rate ; 80 kHz ; 50 kHz ; 50 kHz ; ord_val.equ cr_val.equ splk out splk out splk out ; Configure f ; IO0 CS - a ; IO1 LDAC ; in lacl or</pre>	CLKOUT1 period) x (1+PRD) x (1+TDDR) pr TMS320C203 with 40MHz main clock TDDR PRD 9 24 (18h) 9 39 (27h) 0018h 0029h #0000h, temp; clear timer temp, TIM #prd_val, temp; set PRD temp, PRD #tcr_val, temp; set TDDR, and TRB=1 for auto-reload temp, TCR 100/1 as outputs to be : and set high - and set high temp, ASPCR; configure as output temp #0003h
<pre>period = (0 ; examples fo ; Timer rate 80 kHz ; 50 kHz ; 50 kHz ; out splk out splk out splk out ; Configure 1 ; IO0 CS - a ; IO1 LDAC ; IO1 LDAC ; in lacl or sacl</pre>	CLKOUT1 period) x (1+PRD) x (1+TDDR) pr TMS320C203 with 40MHz main clock TDDR PRD 9 24 (18h) 9 39 (27h) 0018h 0029h #0000h, temp; clear timer temp, TIM #prd_val, temp; set PRD temp, PRD #tcr_val, temp; set TDDR, and TRB=1 for auto-reload temp, TCR TOO/1 as outputs to be : and set high - and set high - and set high temp, ASPCR; configure as output temp #0003h temp
<pre>; period = (0; ; examples fo ; Timer rate ; 80 kHz ; 50 kHz ; 50 kHz ; ord_val.equ ccr_val.equ ccr_val.equ splk out splk out splk out ; 100 CS - a ; 101 LDAC ; in lacl or sacl out</pre>	CLKOUT1 period) x (1+PRD) x (1+TDDR) pr TMS320C203 with 40MHz main clock TDDR PRD 9 24 (18h) 9 39 (27h) 0018h 0029h #0000h, temp; clear timer temp, TIM #prd_val, temp; set PRD temp, PRD #tcr_val, temp; set TDDR, and TRB=1 for auto-reload temp, TCR 
<pre>period = (0 ; examples fo ; Timer rate 80 kHz ; 50 kHz ; 50 kHz ; ord_val.equ cr_val.equ cr_val.equ splk out splk out splk out ; Configure I ; IO0 CS - a ; IO1 LDAC ; in lacl or sacl out in</pre>	CLKOUT1 period) x (1+PRD) x (1+TDDR) pr TMS320C203 with 40MHz main clock TDDR PRD 9 24 (18h) 9 39 (27h) 0018h 0029h #0000h, temp; clear timer temp, TIM #prd_val, temp; set PRD temp, PRD #tcr_val, temp; set TDDR, and TRB=1 for auto-reload temp, TCR 
<pre>period = (0 ; examples fo ; Timer rate 80 kHz ; 50 kHz ; 50 kHz ;</pre>	<pre>CLKOUT1 period) x (1+PRD) x (1+TDDR) pr TMS320C203 with 40MHz main clock TDDR PRD 9 24 (18h) 9 39 (27h) 0018h 0029h #0000h, temp; clear timer temp, TIM #prd_val, temp; set PRD temp, PRD #tcr_val, temp; set TDDR, and TRB=1 for auto-reload temp, TCR 100/1 as outputs to be : and set high - and set high temp, ASPCR; configure as output temp #0003h temp #0003h temp, ASPCR temp, IOSR; set them high temp</pre>
<pre>; period = (0 ; examples fo ; Timer rate ; 80 kHz ; 50 kHz ; 50 kHz ; ord_val.equ cr_val.equ splk out splk out splk out ; Configure 1 ; IO0 CS - a ; IO1 LDAC ; IO1 LDAC ; in lacl out in lacl or</pre>	<pre>CLKOUT1 period) x (1+PRD) x (1+TDDR) pr TMS320C203 with 40MHz main clock TDDR PRD 9 24 (18h) 9 39 (27h) 0018h 0029h #0000h, temp; clear timer temp, TIM #prd val, temp; set PRD temp, PRD #tcr_val, temp; set TDDR, and TRB=1 for auto-reload temp, TCR 100/1 as outputs to be : and set high - and set high temp, ASPCR; configure as output temp #0003h temp temp, ASPCR temp, IOSR; set them high temp #0003h</pre>
<pre>; period = (0 ; examples fo ; Timer rate ; 80 kHz ; 50 kHz ; 50 kHz ; out ; cond_val.equ cr_val.equ splk out splk out splk out splk out ; 100 CS - a ; 101 LDAC ; 101 LDAC ; in lacl or sacl or sacl</pre>	<pre>CLKOUT1 period) x (1+PRD) x (1+TDDR) Dr TMS320C203 with 40MHz main clock TDDR PRD 9 24 (18h) 9 39 (27h) 0018h 0029h #0000h, temp; clear timer temp, TIM #prd_val, temp; set PRD temp, PRD #tcr_val, temp; set TDDR, and TRB=1 for auto-reload temp, TCR 100/1 as outputs to be : and set high - and set high temp, ASPCR; configure as output temp #0003h temp, IOSR; set them high temp #0003h temp</pre>
<pre>period = (0 rexamples fo rimer rate 80 kHz 50 kHz 50 kHz rord_val.equ cr_val.equ splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out sacl or sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out</pre>	<pre>CLKOUT1 period) x (1+PRD) x (1+TDDR) pr TMS320C203 with 40MHz main clock TDDR PRD 9 24 (18h) 9 39 (27h) 0018h 0029h #0000h, temp; clear timer temp, TIM #prd val, temp; set PRD temp, PRD #tcr_val, temp; set TDDR, and TRB=1 for auto-reload temp, TCR 100/1 as outputs to be : and set high - and set high temp, ASPCR; configure as output temp #0003h temp temp, ASPCR temp, IOSR; set them high temp #0003h</pre>
<pre>period = (0 rexamples fo rimer rate 80 kHz 50 kHz 50 kHz rord_val.equ cr_val.equ splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out splk out sacl or sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out sacl out</pre>	<pre>CLKOUT1 period) x (1+PRD) x (1+TDDR) pr TMG320C203 with 40MHz main clock TDDR PRD 9 24 (18h) 9 39 (27h) 0018h 0029h #0000h, temp; clear timer temp, TIM #prd_val, temp; set PRD temp, PRD #tcr_val, temp; set TDDR, and TRB=1 for auto-reload temp, TCR 100/1 as outputs to be : and set high - and set high - and set high temp #0003h temp temp, ASPCR; configure as output temp #0003h temp temp, ASPCR temp floss </pre>
<pre>period = (0 ; examples fo ; Timer rate 80 kHz ; 50 kHz ; 50 kHz ; ord_val.equ ccr_val.equ ccr_val.equ splk out splk out splk out ; 100 CS - a ; 101 LDAC ; 101 LDAC ; 101 LDAC ; in lacl or sacl out in lacl or sacl out ; set up series ; set up series ; in series ; in series ; set up series ; in ser</pre>	<pre>CLKOUT1 period) x (1+PRD) x (1+TDDR) pr TMG320C203 with 40MHz main clock TDDR PRD 9 24 (18h) 9 39 (27h) 0018h 0029h #0000h, temp; clear timer temp, TIM #prd_val, temp; set PRD temp, PRD #tcr_val, temp; set TDDR, and TRB=1 for auto-reload temp, TCR 100/1 as outputs to be : and set high - and set high - and set high temp #0003h temp temp, ASPCR; configure as output temp #0003h temp temp, IOSR; set them high temp temp, IOSR</pre>
<pre>period = (0 ; examples fo ; Timer rate 80 kHz ; 50 kHz ; 50 kHz ; ord_val.equ ccr_val.equ ccr_val.equ splk out splk out splk out ; 100 CS - a ; 101 LDAC ; 101 LDAC ; 101 LDAC ; in lacl or sacl out in lacl or sacl out ; set up series; in ; set up series; in</pre>	<pre>LLKOUT1 period) x (1+PRD) x (1+TDDR) rTMS320C203 with 40MHz main clock TDDR PRD 9 24 (18h) 9 39 (27h) 0018h 0029h #0000h, temp; clear timer temp, TIM #prd_val, temp; set PRD temp, PRD #tcr_val, temp; set TDDR, and TRB=1 for auto-reload temp, TCR 100/1 as outputs to be : and set high - and set high temp, ASPCR; configure as output temp #0003h temp temp, ASPCR temp, IOSR ial port for Transmit mode - generate FSX</pre>
<pre>; period = (0; ; examples fo ; Timer rate ; 80 kHz ; 50 kHz ; 50 kHz ; ord_val.equ cr_val.equ cr_val.equ splk out splk out splk out ; configure 1 ; IOO CS - a ; IO1 LDAC ; IO1 LDAC ; IO1 LDAC ; IO1 LDAC ; sacl out in lacl or sacl out ; SSPCR.TXM=1 ; SSPCR.FSM=1</pre>	<pre>LLKOUT1 period) x (1+PRD) x (1+TDDR) pr TMS320C203 with 40MHz main clock TDDR PRD 9 24 (18h) 9 39 (27h) 0018h 0029h #0000h, temp; clear timer temp, TIM #prd val, temp; set PRD temp, PRD #temp, Set TDDR, and TRB=1 for auto-reload temp. TCR 00/1 as outputs to be : and set high - and set high temp ASPCR; configure as output temp #0003h temp temp, ASPCR temp, IOSR; set them high temp #0003h temp #0003h temp #temp, IOSR; set them high temp #0003h temp #temp, IOSR</pre>
<pre>; period = (0; ; examples fo ; Timer rate ; 80 kHz ; 50 kHz ; 50 kHz ; ord_val.equ cr_val.equ cr_val.equ splk out splk out splk out ; configure 1 ; IOO CS - a ; IO1 LDAC ; IO1 LDAC ; IO1 LDAC ; IO1 LDAC ; sacl out in lacl or sacl out ; SSPCR.TXM=1 ; SSPCR.FSM=1 ; SSPCR.FSM=1</pre>	<pre>LLKOUT1 period) x (1+FRD) x (1+TDDR) pr TMS320C203 with 40MHz main clock TDDR PRD 9 24 (18h) 9 39 (27h) 0018h 0029h #0000h, temp; clear timer temp, TIM #prd_val, temp; set PRD temp, PRD #tcr_val, temp; set TDDR, and TRE=1 for auto-reload temp, TCR 100/1 as outputs to be : and set high temp ASPCR; configure as output temp #0003h temp, ASPCR temp, IOSR; set them high temp #0003h temp #0004h temp</pre>
<pre>s period = (0 s examples fo s Timer rate s 80 kHz s 50 kHz s 50 kHz s out s splk out s splk out s splk out s splk out s splk out s 100 CS - a s 101 LDAC in lacl or s acl out in lacl or s acl out s SSPCR.TXM=1 s SSPCR.FSM=1 s splk</pre>	<pre>LLKOUT1 period) x (1+PRD) x (1+TDDR) pr TMS320C203 with 40MHz main clock TDDR PRD 9 24 (18h) 9 39 (27h) 0018h 0029h #0000h, temp; clear timer temp, TIM #prd_val, temp; set PRD temp, PRD #tcr_val, temp; set TDDR, and TRB=1 for auto-reload temp, TCR 00/1 as outputs to be : and set high - and set high temp, ASPCR; configure as output temp, MSPCR; set them high temp temp, IOSR; set them high temp #0003h temp temp, IOSR; set them high temp temp, IOSR ial port for Transmit mode - generate FSX Clock mode - internal clock source #0000Eh, temp</pre>
<pre>period = (0 ; examples fo ; Timer rate 80 kHz 50 kHz 50 kHz ord_val.equ cr_val.equ cr_val.equ splk out splk out splk out ; Configure 1 ; IO0 CS - a ; IO1 LDAC ; IO1 LDAC ; IO1 LDAC ; IO1 LDAC ; IO1 LDAC ; Sorr sacl out in lacl or sacl out ; SSPCR.TXM=1 ; SSPCR.FSM=1 ; SSPCR.FSM=1 ; Splk out</pre>	<pre>LLKOUT1 period) x (1+PRD) x (1+TDDR) pr TMS320C203 with 40MHz main clock TDDR PRD 9 24 (18h) 9 39 (27h) 0018h 0029h #0000h, temp; clear timer temp, TIM #prd_val, temp; set PRD temp, PRD #tcr_val, temp; set TDDR, and TRB=1 for auto-reload temp, TCR 100/1 as outputs to be : and set high - and set high - and set high temp, ASPCR; configure as output temp #0003h temp #0003h temp temp, IOSR; set them high temp #0003h temp, IOSR ial port for 1 Transmit mode - generate FSX 1 Clock mode - internal clock source Burst mode</pre>
<pre>period = (0 ; examples fo ; Timer rate 80 kHz 50 kHz 50 kHz ord_val.equ cr_val.equ cr_val.equ splk out splk out splk out ; Configure 1 ; IO0 CS - a ; IO1 LDAC ; IO1 LDAC ; IO1 LDAC ; IO1 LDAC ; IO1 LDAC ; Sorr sacl out in lacl or sacl out ; SSPCR.TXM=1 ; SSPCR.FSM=1 ; SSPCR.FSM=1 ; Splk out</pre>	<pre>LLKOUT1 period) x (1+PRD) x (1+TDDR) pr TMS320C203 with 40MHz main clock TDDR PRD 9 24 (18h) 9 39 (27h) 0018h 0029h #0000h, temp; clear timer temp, TIM #prd_val, temp; set PRD temp, PRD #tcr_val, temp; set TDDR, and TRB=1 for auto-reload temp, TCR 00/1 as outputs to be : and set high - and set high temp, ASPCR; configure as output temp #0003h temp #0003h temp #0003h temp femp, IOSR; set them high temp temp, IOSR ial port for Transmit mode - generate FSX Clock mode - internal clock source #0000Eh, temp</pre>



; reset the rolling pointer ;------#000h lacl r\_ptr sacl ;------\_\_\_\_\_ ; enable interrupts \_\_\_\_\_ ;-----\_ \_ \_ \_ \_ \_ \_ \_ \_ \_ clrc INTM ; enable maskable interrupts ;------; loop forever! \_\_\_\_\_ ;----next idle ;wait for interrupt b next ;all else fails stop here ;------\_\_\_\_\_ done b done ; hang there ; Interrupt Service Routines ;-----int1 ret ; do nothing and return ; do nothing and return int23 ret timer isr: in iosr\_stat, IOSR; store IOSR value into variable space lacl iosr stat ; load acc with iosr status and #0FFFDh ; reset IO1 - LDAC low sacl temp ; out temp, IOSR; #0002h or ; set IO1 - LDAC high sacl temp ; out temp, IOSR; #0FFFEh ; reset IOO - CS low and sacl temp ; temp, IOSR; out lacl r\_ptr ; load rolling pointer to accumulator #sinevals ; add pointer to table start add sacl DACa\_ptr ; to get a pointer for next DAC a sample add #08h ; add 8 to get to DAC C pointer sacl DACc\_ptr add #08h ; add 8 to get to DAC B pointer sacl DACb\_ptr add #08h ; add 8 to get to DAC D pointer sacl DACd ptr mar \*,ar0 ; set ar0 as current AR ; DAC A ar0, DACa\_ptr; ar0 points to DAC a sample lar \* ; get DAC a sample into accumulator lacl #DACa\_control ; OR in DAC A control bits or sacl temp ; out temp, SDTR; send data ;-----; We must wait for transmission to complete before writing next word to the SDTR.; TLV5614/04 interface does not allow the use of burst mode with the full packet; rate, as we need a CLKX -ve edge to clock in last bit before FS goes high again,; to allow SPI

compatibility.

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SLAS391A - JULY 2003 - REVISED AUGUST 2003

rpt #016h ; wait long enough for this configuration ; of MCLK/CLKOUT1 rate nop ; DAC B lar ar0, dacb\_ptr; ar0 points to DAC a sample lacl \* ; get DAC a sample into accumulator or #DACb\_control; OR in DAC B control bits sacl temp ; temp, SDTR; send data out rpt #016h ; wait long enough for this configuration nop ; of MCLK/CLKOUT1 rate ; DAC C lar ar0, dacc ptr; ar0 points to dac a sample ; get DAC a sample into accumulator lacl \* or #DACc control; OR in DAC C control bits temp sacl ; temp, SDTR; send data out #016h ; wait long enough for this configuration rpt ; of MCLK/CLKOUT1 rate nop ; DAC D ar0, dacd\_ptr; ar0 points to DAC a sample lar \* ; get DAC a sample into accumulator lacl #dacd\_control; OR in DAC D control bits or sacl temp temp, SDTR; send data out lacl ; load rolling pointer to accumulator r\_ptr #1h ; increment rolling pointer add ; count 0-31 then wrap back round #001Fh and sacl ; store rolling pointer r ptr ; wait long enough for this configuration rpt #016h ; of MCLK/CLKOUT1 rate nop ; now take CS high again lacl iosr stat ; load acc with iosr status ; set IOO - CS high #000<u>1</u>h or sacl temp ; temp, IOSR; out ; re-enable interrupts clrc intm ret ; return from interrupt .end

## TLV5614IYE INTERFACED TO MCS®51 MICROCONTROLLER

### Hardware Interfacing

Figure 19 shows an example of how to connect the TLV5614IYE to an MCS<sup>®</sup>51 Microcontroller. The serial DAC input data and external control signals are sent via I/O Port 3 of the controller. The serial data is sent on the RxD line, with the serial clock output on the TxD line. Port 3 bits 3, 4, and 5 are configured as outputs to provide the DAC latch update (LDAC), chip select (CS) and frame sync (FS) signals for the TLV5614IYE. The active low power down pin (PD) of the TLV5614IYE is pulled high to ensure that the DACs are enabled.

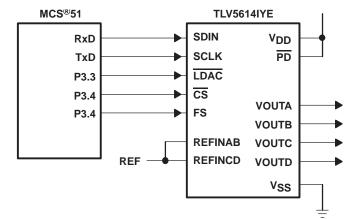


Figure 19. TLV5614IYE Interfaced With MCS<sup>®</sup>51

### Software

The example is the same as for the TMS320C203 in this data sheet, but adapted for a MCS<sup>®</sup>51 controller. It generates a differential in-phase (sine) signal between the VOUTA and VOUTB pins, and its quadrature (cosine) signal is the differential signal between VOUTC and VOUTD.

The on-chip timer is used to generate interrupts at a fixed frequency. The related interrupt service routine pulses  $\overline{\text{LDAC}}$  low to update all 4 DACs simultaneously, then fetches and writes the next sample to all 4 DACs. The samples are stored as a look-up table, which describes one full period of a sine wave.

The serial port of the controller is used in Mode 0, which transmits 8 bits of data on RxD, accompanied by a synchronous clock on TxD. Two writes concatenated together are required to write a complete word to the TLV5614IYE. The CS and FS signals are provided in the required fashion through control of IO port 3, which has bit addressable outputs.

```
Processor: 80C51
; Description:
 This program generates a differential in-phase
(sine) on (OUTA-OUTB) ; and it's quadrature (cosine)
as a differential signal on (OUTC-OUTD).
 © 1998, Texas Instruments Inc.
;
      GENIO
NAME
MAIN
      SEGMENT
                    CODE
ISR
      SEGMENT
                    CODE
SINTBL SEGMENT
                    CODE
VAR1
      SEGMENT
                    DATA
STACK SEGMENT
                    IDATA
; Code start at address 0, jump to start
                 _____
                           ____
   CSEG AT
              0
   LJMP start
                       ; Execution starts at address 0 on power-up.
  _____
; -
```

SLAS391A - JULY 2003 - REVISED AUGUST 2003



; Code in the timer0 interrupt vector ;-----CSEG AT OBH LJMP timer0isr ; Jump vector for timer 0 interrupt is 000Bh ·-----; Global variables need space allocated ;-----\_\_\_\_\_ RSEG VAR1 KSEG ... temp\_ptr: DS 1 rolling\_ptr: DS 1 ; Interrupt service routine for timer 0 interrupts \_\_\_\_\_ ; \_\_\_\_\_ RSEG ISR timer0isr: PUSH PSW PUSH ACC CLR INT1 ; pulse LDAC low SETB INT1 ; to latch all 4 previous values at the same time ; 1st thing done in timer isr => fixed period CLR ΤO ; set CS low ; The signal to be output on each DAC is a sine function. One cycle of a sine wave is ; held in a table @ sinevals as 32 samples of msb, lsb pairs (64 bytes). ; We have ; one pointer which rolls round this table, rolling\_ptr incrementing by ; 2 bytes (1 sample) on each interrupt (at the end of this routine). ; The DAC samples are read at an offset to this rolling pointer: ; DAC Function Offset from rolling\_ptr ; A sine 0 ; B inverse sine 32 ; C cosine 16 D inverse cosine48 MOV DPTR, #sinevals; set DPTR to the start of the table of sine signal values MOV R7, rolling ptr; R7 holds the pointer into the sine table ; get DAC A msb ; msb of DAC A is in the ACC MOV A,R7 A,@A+DPTR MOVC CLR T1; transmit it - set FS low ; send it out the serial port MOV SBUF,A TNC R7 ; increment the pointer in R7 ; to get the next byte from the table ; which is the lsb of this sample, now in ACC MOV A,R7 MOVC A,@A+DPTR A MSB TX: JNB TI,A\_MSB\_TX ; wait for transmit to complete ; clear for new transmit ; and send out the lsb of DAC A CLR TI MOV SBUF,A ; DAC C next ; DAC C codes should be taken from 16 bytes (8 samples) further on ; in the sine table - this gives a cosine function ; pointer in R7 MOV A,R7 A,#0FH ; add 15 - already done one INC ADD A, #03FH; wrap back round to 0 if > 64 ANT. ; pointer back in R7 MOV R7.A MOVC A,@A+DPTR ; get DAC C msb from the table ; set control bits to DAC C address ORL A,#01H A LSB TX:  ${\tt TI}, {\tt A\_LSB\_TX}$  ; wait for DAC A lsb transmit to complete JNB SETB Τ1 ; toggle FS CLR T1 CLR ͲТ ; clear for new transmit ; and send out the msb of DAC C MOV SBUF,A ; increment the pointer in R7 INC R7 A,R7 ; to get the next byte from the table A,@A+DPTR ; which is the lsb of this sample, now in ACC MOV MOVC C MSB TX: TI,C\_MSB\_TX ; wait for transmit to complete JNB ; clear for new transmit CLR ΤI MOV SBUF,A ; and send out the lsb of DAC C

; DAC B next ; DAC B codes should be taken from 16 bytes (8 samples) further on ; in the sine table - this gives an inverted sine function MOV A,R7 ; pointer in R7 A,#0FH ; add 15 - already done one INC ADD ; wrap back round to 0 if > 64 ANL A,#03FH ; pointer back in R7 MOV R7,A ; get DAC B msb from the table ; set control bit MOVC A,@A+DPTR ORL A,#02H ; set control bits to DAC B address C LSB TX: JNB TI, C LSB TX ; wait for DAC C lsb transmit to complete SETB T1 ; toggle FS CLB т1 CLR ΤI ; clear for new transmit MOV SBUF,A ; and send out the msb of DAC B ; get DAC B LSB ; increment the pointer in R7 TNC R7 A,R7 MOV ; to get the next byte from the table MOVC ; which is the lsb of this sample, now in ACC A,@A+DPTR B MSB TX: JNB TI,B\_MSB\_TX ; wait for transmit to complete \_\_\_\_\_; clear for new transmit SBUF,A ; and send out the lsb of DAC B CLR ΤI MOV ; DAC D next ; DAC D codes should be taken from 16 bytes (8 samples) further on ; in the sine table - this gives an inverted cosine function MOV ; pointer in R7 A,R7 ADD A,#OFH ; add 15 - already done one INC ANT. A,#03FH ; wrap back round to 0 if > 64 ; pointer back in R7 ; get DAC D msb from the table ; set control bits to DAC D address MOV R7,A A,@A+DPTR MOVC A,#03H ORT B LSB TX:  $\texttt{TI},\texttt{B\_LSB\_TX}$  ; wait for DAC B lsb transmit to complete JNB SETB T1 ; toggle FS CLR Т1 TI ; clear for new transmit CLR ; and send out the msb of DAC D MOV SBUF, A R7 ; increment the pointer in R7 A,R7 ; to get the INC MOV ; to get the next byte from the table A,@A+DPTR ; which is the lsb of this sample, now in ACC MOVC D MSB TX: JNB TI,D\_MSB\_TX ; wait for transmit to complete CLR ΤI ; clear for new transmit ; and send out the lsb of DAC D MOV SBUF,A ; increment the rolling pointer to point to the next sample ; ready for the next interrupt A,rolling\_ptr MOV ; add 2 to the rolling pointer ; wrap back round to 0 if > 64 A,#02H ADD A,#03FH ANL rolling ptr,A; store in memory again MOV D\_LSB\_TX: JNB TI,D LSB TX ; wait for DAC D lsb transmit to complete ; clear for next transmit TI CLR Τ1 SETB ; FS high ТO ; CS high SETB POP ACC POP PSW RETI ; Stack needs definition \_\_\_\_\_

```
RSEG STACK
DS 10h
```

; 16 Byte Stack!

SLAS391A - JULY 2003 - REVISED AUGUST 2003



; Main pr	ogram code	
,		
RSEG	MAIN	
start:		finat act Otacle Daintan
MOV	SP,#SIACK-I	; first set Stack Pointer
CLR A MOV	SCON, A	, get gerial part 0 to mode 0
MOV	TMOD #024	; set serial port 0 to mode 0 ; set timer 0 to mode 2 - auto-reload
MOV	TMOD,#02H TTTO #039U	, set TWO for $5kHg$ interrupts
SETB	INT1	; set timer 0 to mode 2 - auto-reload ; set TH0 for 5kHs interrupts ; set LDAC = 1
SETB		; set $FS = 1$
SETB		; set $CS = 1$
SETB	ETO	: enable timer 0 interrupts
SETB	EA	; enable all interrupts
MOV	rolling ptr, A	A; set rolling pointer to 0
SETB		; start timer 0
always:		
SJMP	always	; while(1) !
RET		
D	W 0903EH W 05097H W 0305CH W 0B086H	
	W 070CAH	
D	W OFOEOH	
D	W OF06EH	
D	W 0F039H	
	W OF06EH	
	W OFOEOH	
	W 070CAH	
	W 0B086H W 0305CH	
-	W 0305CH W 05097H	
	W 0903EH	
	W 01000H	
	W 06021H	
	W 0A0E8H	
D	W 0C063H	
	W 040F9H	
	W 080B5H	
	W 0009FH	
	W 00051H	
	UNI ()()') G LT	
E		
D	W 00028H W 00051H W 0009FH	

DW DW DW 06021H

DW

DW

080B5H

040F9H

0C063H

0A0E8H

END



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### PACKAGING INFORMATION

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
TLV5614IYE	ACTIVE	DIESALE	YE	16	120	TBD	Call TI	N / A for Pkg Type
TLV5614IYER	ACTIVE	DIESALE	YE	16	3000	TBD	Call TI	N / A for Pkg Type

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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